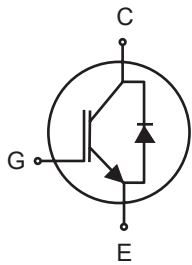
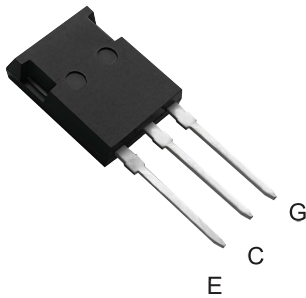
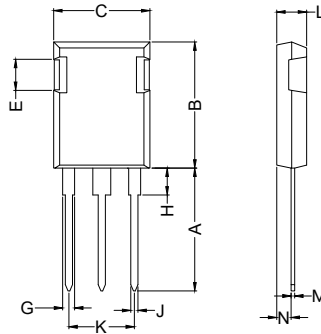


SG120T65UDB5

Discrete IGBTs



G = Gate
C = Collector
E = Emitter
TAB = Collector



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	19.81	20.32	0.780	0.800
B	20.80	21.46	0.819	0.845
C	15.75	16.26	0.620	0.640
E	4.32	5.49	0.170	0.216
F	5.4	6.3	0.213	0.248
G	1.65	2.13	0.065	0.084
H	3.80	4.5	0.150	0.177
J	1.0	1.4	0.039	0.055
K	10.8	11.1	0.425	0.437
L	4.7	5.3	0.185	0.209
M	0.4	0.8	0.016	0.031
N	1.5	2.49	0.059	0.098



Symbol	Test Conditions	Value	Unit
V_{CES}	$T_J=25^{\circ}\text{C}$ to 150°C	650	V
V_{GES}		± 20	V
I_C	$T_C=25^{\circ}\text{C}$; limited by leads	240	A
	$T_C=100^{\circ}\text{C}$	120	
RBSOA	$V_{GE}=15\text{V}$; $T_{VJ}=125^{\circ}\text{C}$; $R_G=5\Omega$, $V_{CE}=480\text{V}$	300	A
P_D	$T_C=25^{\circ}\text{C}$	500	W
T_J		-55 ~ +175	$^{\circ}\text{C}$
T_{JM}		175	
T_{STG}		-55 ~ +150	
	Maximum Lead temperature for soldering 1.6mm (0.062 in.) from case for 10s Maximum Tabk temperature for soldering SMD devices for 10s	300	$^{\circ}\text{C}$
		260	$^{\circ}\text{C}$
Md	Mounting Torque (M3)	1.13/10	Nm/ lb.in
Weight		6	g

SG120T65UDB5

Discrete IGBTs

Symbol	Test Conditions	Min	Typ.	Max	Unit
IGBT(T_J=25°C, unless otherwise specified)					
B _{VCEs}	I _C = 1mA; V _{GE} = 0V	650			V
V _{GETH}	I _C = 250μA; V _{CE} = V _{GE}	4.4	5.2	6.0	V
I _{CES}	V _{CE} =650V; V _{GE} =0V	T _J =25°C		250	μA
		T _J =125°C		4	mA
I _{GES}	V _{CE} =0V; V _{GE} =±20V			±200	nA
V _{CE(SAT)}	I _C =120A; V _{GE} =15V		1.90	2.40	V
C _{ies}	V _{CE} =25V; V _{GE} =0V; f=1MHz		5500		pF
C _{oes}			335		
C _{res}			55		
Q _g	I _C =120A; V _{GE} =15V; V _{CE} =520V		150		nC
Q _{ge}			30		
Q _{gc}			147		
t _{d(on)}	Inductive Load I _C =120A; V _{GE} =15V; V _{CE} =400V; R _{G(ON)} =R _{G(OFF)} =20Ω;		100		ns
t _r			180		ns
t _{d(off)}			260		ns
t _f			90		ns
E _{on}			7.1		mJ
E _{off}			7.8		mJ
R _{thJC}				0.25	K/W
R _{thJA}				40	K/W
Reverse Diode (FRED)					
V _F	I _F =120A; T _{VJ} =25°C		2.8	3.0	V
I _{RM}	V _R =400V; I _F =120A; -di _F /dt = 100A/μs L≤0.05μH; T _{VJ} =100°C		6		A
t _{rr}	I _F =1A; -di/dt=50A/μs; V _R =30V; T _J =25°C		75		ns
R _{thJC}				0.40	K/W

Features:

- Low Switching Losses
- Short circuit withstand time 5us
- Positive Temperature Coefficient for easy paralleling
- MOS input, Voltage Controlled
- Ultrafast Free Wheeling Diodes

Application:

- UPS
- Welding Machines
- PFC applications

Advantages:

- Space and weight savings
- Reduced protection circuits